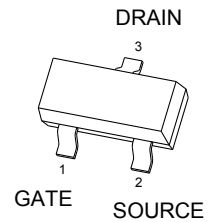
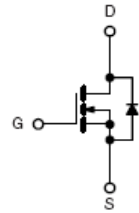




MT3404 N-Channel 30-V(D-S) MOSFET

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
30V	0.025 Ω @ 10V	5.8A
	0.035 Ω @ 4.5V	



General FEATURE

- TrenchFET Power MOSFET
- Lead free product is acquired
- Surface mount package

APPLICATION

- Load Switch for Portable Devices
- DC/DC Converter

SOT-23

MARKING :3404

Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	5.8	A
Pulsed Drain Current*1	I_{DM}	20	
Continuous Source-Drain Diode Current	I_S	1.0	
Maximum Power Dissipation	P_D	1.4	W
Thermal Resistance from Junction to Ambient($t \leq 10\text{s}$)	$R_{\theta JA}$	89	$^{\circ}\text{C/W}$
Junction Temperature	T_J	-55 ~ +150	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-55 ~ +150	

Note :

*1. Pulse Width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$



MOSFET ELECTRICAL CHARACTERISTICS

T_a =25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D = 250μA	1.2	1.6	2.4	
Gate-source leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} =24V, V _{GS} =0V	-	-	100	nA
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} =10V, I _D =5.8A	-	0.023	0.025	Ω
		V _{GS} =4.5V, I _D =5A	-	0.032	0.035	
Forward transconductance ^a	g _{fs}	V _{DS} =5V, I _D =5A	-	15	-	S
Dynamic ^b						
Input capacitance	C _{iSS}	V _{DS} =15V,V _{GS} =0V,f =1MHz	-	255	-	pF
Output capacitance	C _{oSS}		-	45	-	
Reverse transfer capacitance	C _{rSS}		-	35	-	
Total gate charge	Q _g	V _{DS} =15V,V _{GS} =10V ,I _D =5.0A	-	5.2	-	nC
Gate-source charge	Q _{gs}		-	0.85	-	
Gate-drain charge	Q _{gd}		-	1.3	-	
Turn-on delay time	t _{d(on)}	V _{DD} =15V,R _L =3Ω V _{GS} =10V ,R _{gen} =3Ω	-	4.5	-	ns
Rise time	t _r		-	2.5	-	
Turn-off delay time	t _{d(off)}		-	14.5	-	
Fall time	t _f		-	3.5	-	
Drain-source body diode characteristics						
Continuous source-drain diode current	I _s	T _C =25°C	-	-	2.5	A
Body diode voltage	V _{SD}	I _s =1.0A	-	0.7	1.0	V

Notes :

a. Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.

b. Guaranteed by design, not subject to production testing.



Typical Electrical and Thermal Characteristics

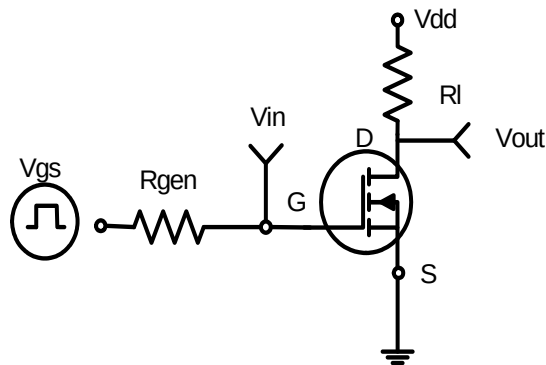


Figure 1: Switching Test Circuit

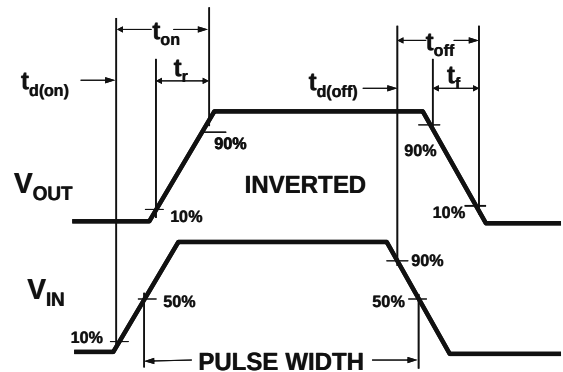


Figure 2: Switching Waveforms

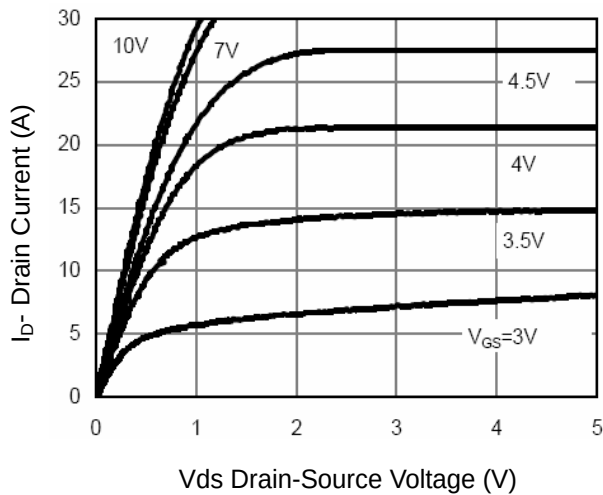


Figure 3: Output Characteristics

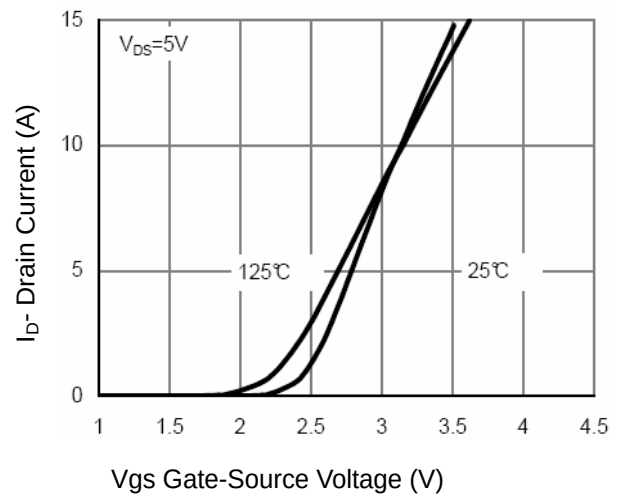


Figure 4: Transfer Characteristics

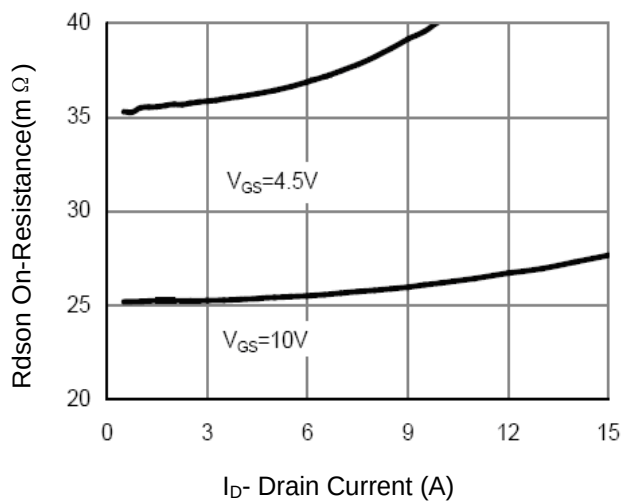


Figure 5: Drain-Source On-Resistance

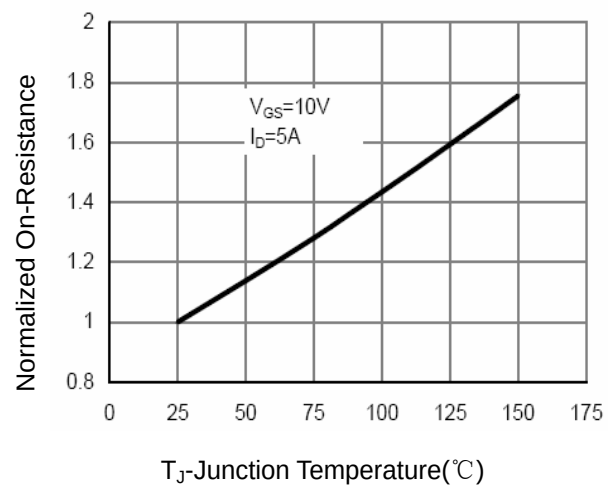


Figure 6: Drain-Source On-Resistance

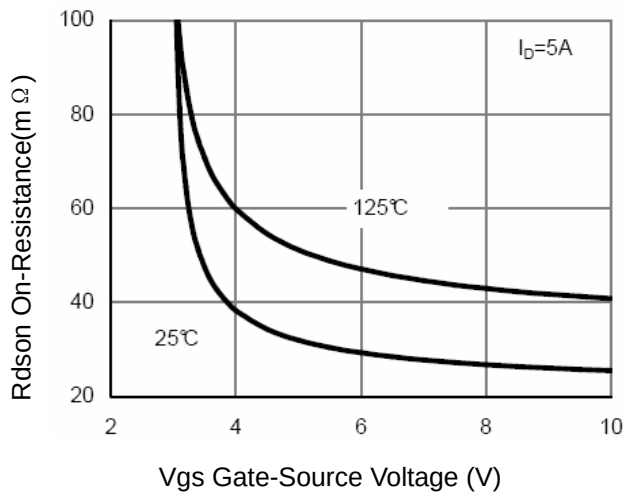


Figure 7 Rdson vs Vgs

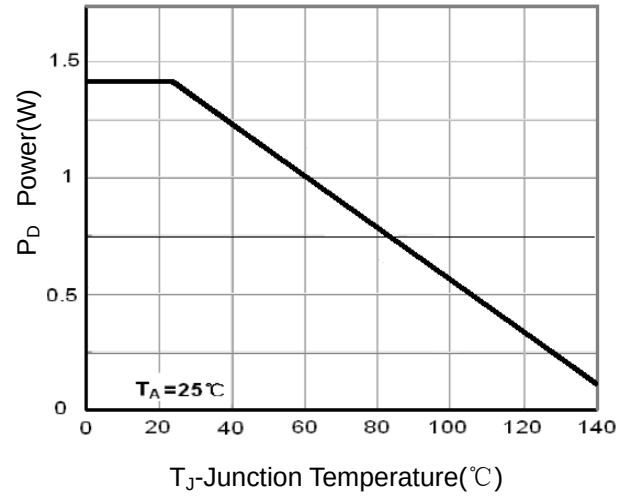


Figure 8 Power Dissipation

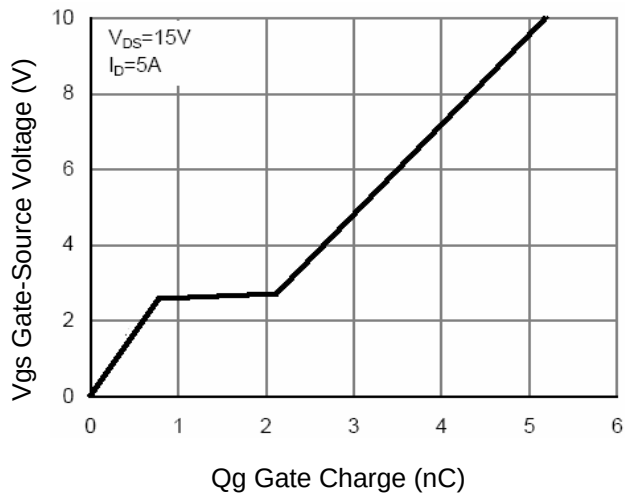


Figure 9 Gate Charge

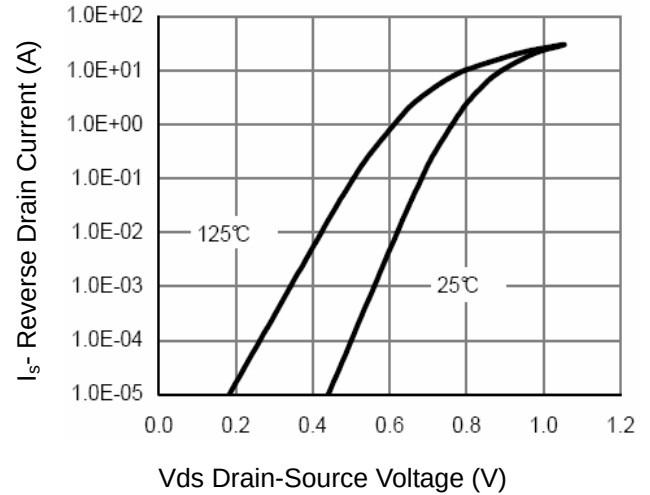


Figure 10 Source- Drain Diode Forward

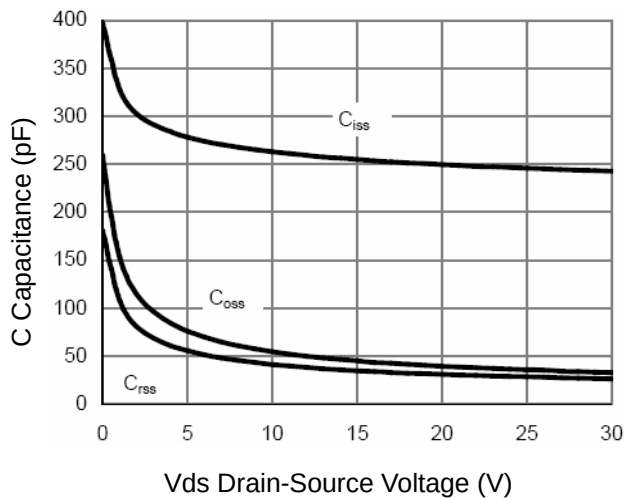


Figure 11 Capacitance vs Vds

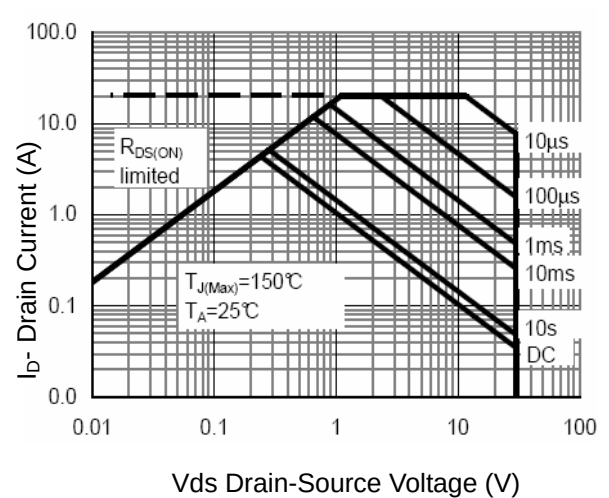


Figure 12 Safe Operation Area

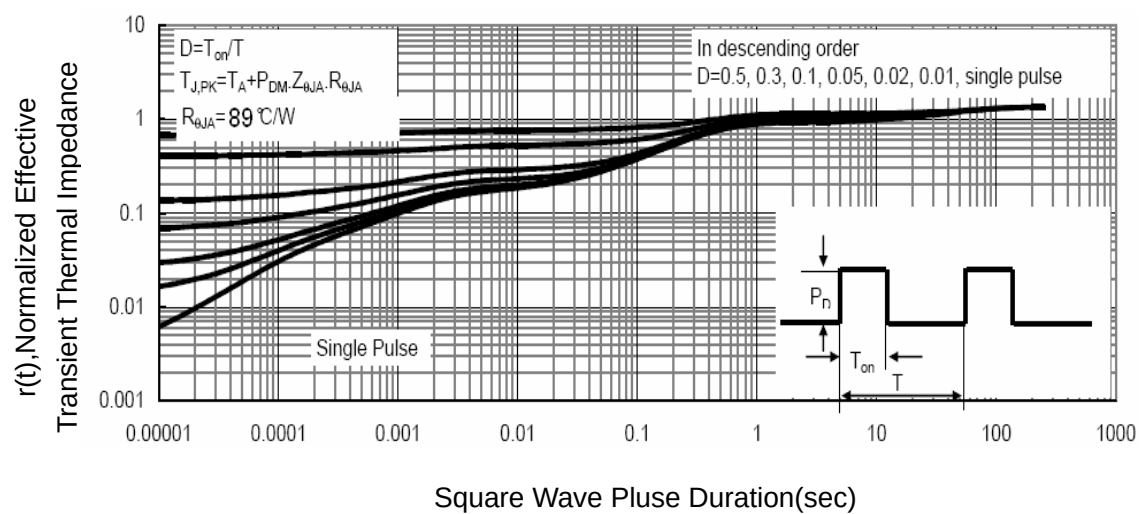


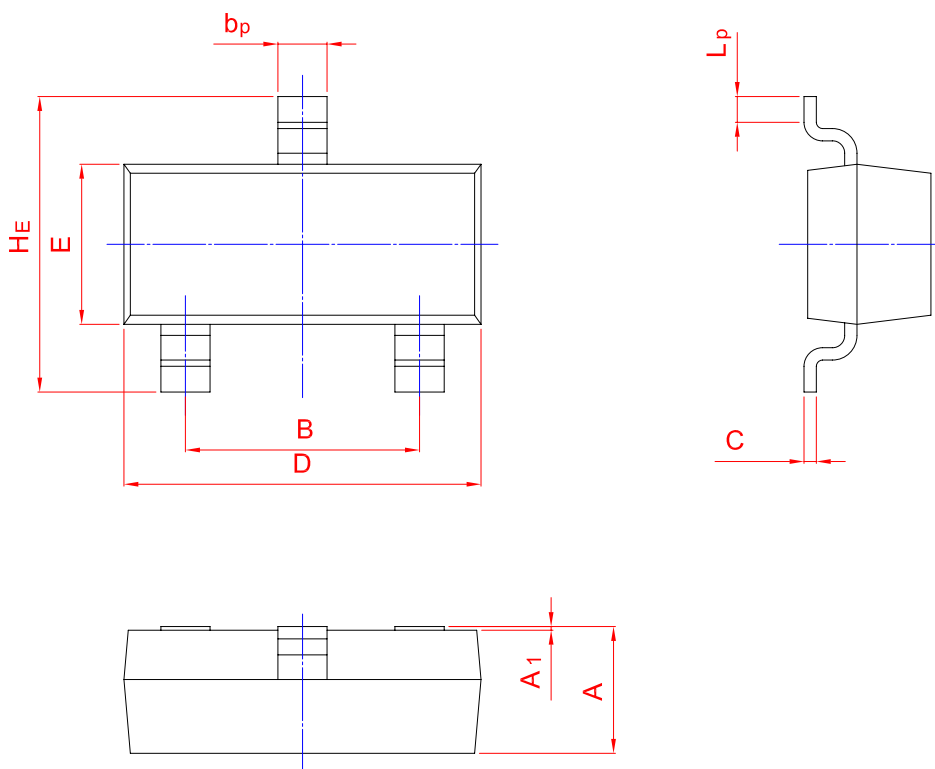
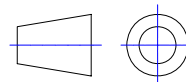
Figure 13 Normalized Maximum Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	bp	C	D	E	HE	A1	Lp
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20